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				Application Number	R53(b) CONT, of S.N. 09/613.138	
1	INFORMATION DISC	LOS	JRE	Filing Date	March 11, 2004	
	STATEMENT BY APP	LIC	ANT	First Named Inventor	T. SAITO et al	
(use as many sheets as necessary)				Art Unit	2814	
				Examiner Name	P. CAO	
Sheet	1	of	2	Attorney Docket Number	501.36455CC2	

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Examiner Initials'	Cite No.1	Document Number  Number-Kind Code <sup>2</sup> (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	
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		Country Code3-Number4-Kind Code 5(# known)		Applicant of Cited Document	or Relevant Figures Appear	<u> </u>
PC		JP-A-8-78410	3/22/1996			AB
bc		JP-A-8-148560	06/07/1996			A8
1.						<u>↓</u>
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	INFORMATION DIS	CLOSU	IRE	Application Number Filing Date	R53(b) CONT. of S.N. 09/613,138 March 11, 2004	
	STATEMENT BY A	PPLICA	NT	First Named Inventor	T. SAITO et al	
				Group Art Unit	2814	
	(use as many sheets as	necessar	0	Examiner Name	P. CAO	
Sheet	2	of	2	Attorney Docket Number	501.36455CC2	

		OTHER PRIOR ART—NON PATENT LITERATURE DOCUMENTS	
Examiner Initials*	Cite No.1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), sublished article and or country when authlished	T²
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